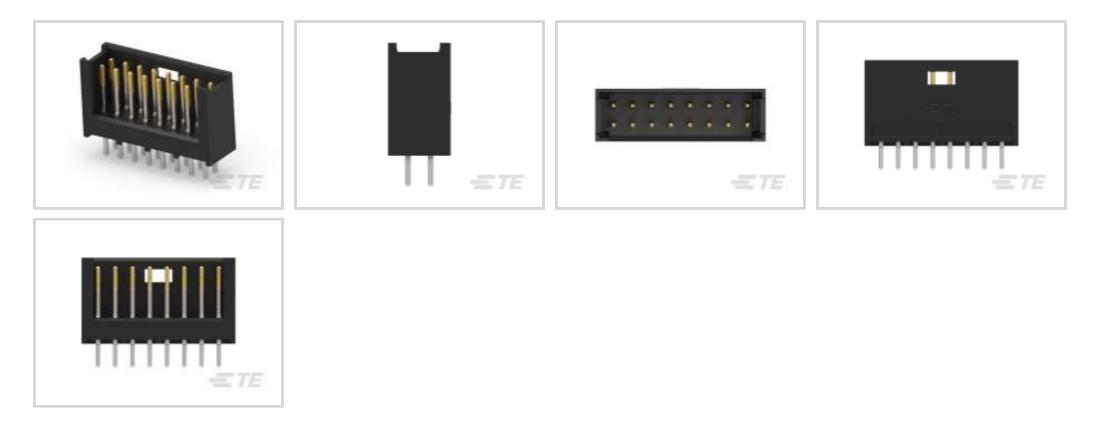


### AMPMODU | AMPMODU Headers

TE Internal #: 280385-2 PCB Mount Header, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 16

Number of Rows: 2

## Features

**E** 

## **Product Type Features**

Connector SystemBoard-to-BoardHeader TypePartially ShroudedSealableNoConnector & Contact Terminates ToPrinted Circuit BoardConfiguration Features					
SealableNoConnector & Contact Terminates ToPrinted Circuit Board					
Connector & Contact Terminates To Printed Circuit Board					
Configuration Features					
Connector Contact Load Condition Fully Loaded					
PCB Mount Orientation Vertical					
Number of Positions 16					
Number of Rows 2					
Electrical Characteristics					
Dielectric Withstanding Voltage (Max) 750 V					
Body Features					
Connector Profile Standard					

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Primary Product Color	Black
Contact Features	
PCB Contact Termination Area Plating Material Thickness	2.5 µm
Contact Shape & Form	Round
Contact Mating Area Plating Material Finish	Bright
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]
Contact Type	Pin
Termination Features	
Termination Post & Tail Length	3.5 mm[.138 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	With
Panel Mount Feature	Without
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



### Packaging Features

Packaging Quantity	500
Packaging Type	Box

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



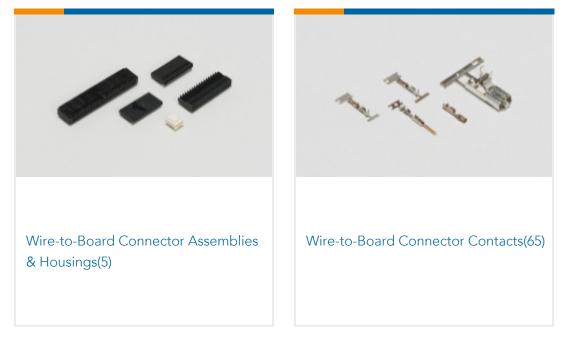
# Also in the Series AMPMODU Headers

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers







# Customers Also Bought



TE Part #280509-2 18 POS .100DR MODU-	TE Part #280521-2 2X12P MODU II SHRD HDR, ST, 0.38AU	TE Part #280384-2 2X4P AMPMODU II SHRD HDR,ST,0.38 AU	TE Part #280378-2 4P MODU II SHRD HDR, RT ANG, 0.38 AU
201		ALLOW THE TE	ALL
TE Part #2-2176328-8 CRGP 1206 1K8 1%	TE Part #1-2176379-1 RQ 0805 137R 0.1% 10PPM 5K RL	TE Part #280372-2 6P AMPMODU II SHRD HDR, ST, 0.38 AU	TE Part #280371-2 4P AMPMODU II SHRD HDR, ST, 0.38 AU



## Documents

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU Headers



Product Drawings 2X8P AMPMODU II SHRD HDR,ST,0.38AU

English

**CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_280385-2\_T\_c-280385-2-t.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_280385-2\_T\_c-280385-2-t.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_280385-2\_T\_c-280385-2-t.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance MD\_280385-2\_07222014917\_dmtec

English

MD\_280385-2\_07222014917\_dmtec

English